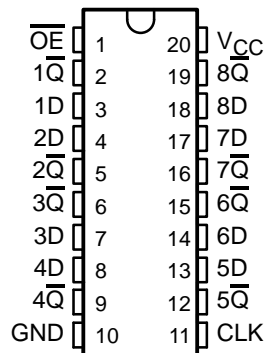


SN54ABT534, SN74ABT534A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

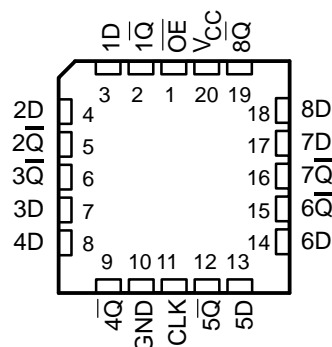
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- State-of-the-Art **EPIC-II^B**™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Package Options Include Plastic Small-Outline (DW) and Shrink Small-Outline (DB) Packages, Ceramic Chip Carriers (FK), Plastic (N) and Ceramic (J) DIPs, and Ceramic Flat (W) Packages

SN54ABT534 . . . J OR W PACKAGE
SN74ABT534A . . . DB, DW, OR N PACKAGE
(TOP VIEW)



SN54ABT534 . . . FK PACKAGE
(TOP VIEW)



description

These 8-bit flip-flops with 3-state outputs are designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops of the SN54ABT534 and SN74ABT534A are edge-triggered D-type flip-flops. On the positive transition of the clock, the \overline{Q} outputs are set to the complement of the logic levels that were set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

The \overline{OE} input does not affect the internal operations of the flip-flop. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT534A is available in TI's shrink small-outline package, which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed circuit board area.

The SN54ABT534 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT534A is characterized for operation from -40°C to 85°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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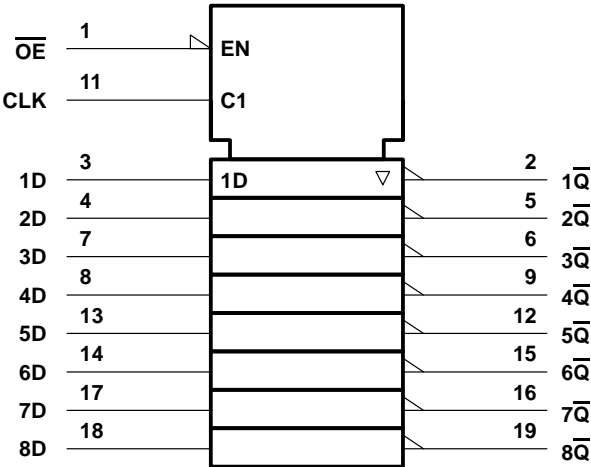
SN54ABT534, SN74ABT534A
OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS
WITH 3-STATE OUTPUTS

SCBS187E – FEBRUARY 1991 – REVISED OCTOBER 1996

FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUT Q
$\overline{\text{OE}}$	CLK	D	
L	↑	H	L
L	↑	L	H
L	H or L	X	$\overline{\text{Q}}_0$
H	X	X	Z

logic symbol†

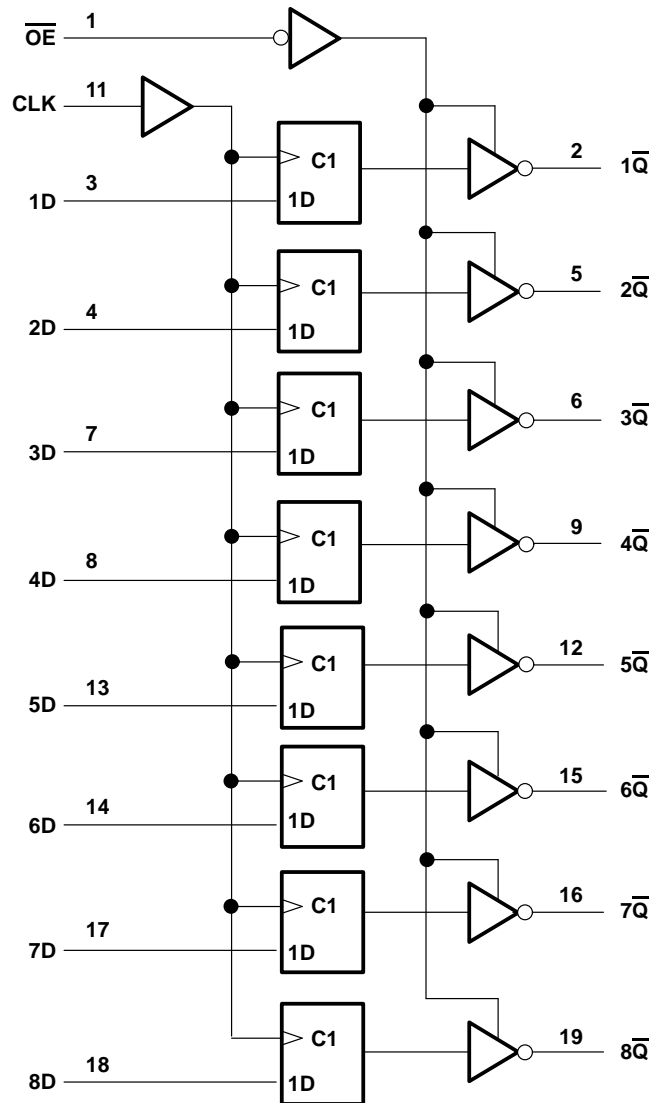


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SN54ABT534, SN74ABT534A
OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS
WITH 3-STATE OUTPUTS

SCBS187E – FEBRUARY 1991 – REVISED OCTOBER 1996

logic diagram (positive logic)



SN54ABT534, SN74ABT534A

OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

SCBS187E – FEBRUARY 1991 – REVISED OCTOBER 1996

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	–0.5 V to 5.5 V
Current into any output in the low state, I_O : SN54ABT534	96 mA
SN74ABT534A	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DB package	0.6 W
DW package	1.6 W
N package	1.3 W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

recommended operating conditions (see Note 3)

		SN54ABT534		SN74ABT534A		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current		–24		–32	mA
I_{OL}	Low-level output current		48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			5	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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SN54ABT534, SN74ABT534A

OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

SCBS187E – FEBRUARY 1991 – REVISED OCTOBER 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T _A = 25°C			SN54ABT534		SN74ABT534A		UNIT
		MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
V _{IK}	V _{CC} = 4.5 V, I _I = -18 mA			-1.2		-1.2		-1.2	V
V _{OH}	V _{CC} = 4.5 V, I _{OH} = -3 mA	2.5			2.5		2.5		V
	V _{CC} = 5 V, I _{OH} = -3 mA	3			3		3		
	V _{CC} = 4.5 V			2	2				
				2*			2		
V _{OL}	V _{CC} = 4.5 V			0.55		0.55			V
				0.55*			0.55		
I _I	V _{CC} = 5.5 V, V _I = V _{CC} or GND			±1		±1		±1	μA
I _{OZH}	V _{CC} = 5.5 V, V _O = 2.7 V			10§		10§		10§	μA
I _{OZL}	V _{CC} = 5.5 V, V _O = 0.5 V			-10§		-10§		-10§	μA
I _{off}	V _{CC} = 0, V _I or V _O ≤ 4.5 V			±100				±100	μA
I _{CEX}	V _{CC} = 5.5 V, V _O = 5.5 V			50		50		50	μA
I _{O‡}	V _{CC} = 5.5 V, V _O = 2.5 V	-50	-100	-180§	-50	-180§	-50	-180§	mA
I _{CC}	V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND			1	250	250		250	μA
				24	30	30		30	mA
				0.5	250	250		250	μA
ΔI _{CC} ¶	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND			1.5		1.5		1.5	mA
C _i	V _I = 2.5 V or 0.5 V			3.5					pF
C _o	V _O = 2.5 V or 0.5 V			6.5					pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V_{CC} = 5 V.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This data sheet limit may vary among suppliers.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54ABT534		UNIT		
			V _{CC} = 5 V, T _A = 25°C			MIN	MAX
			MIN	MAX			
f _{clock}	Clock frequency		125	125	MHz		
t _w	Pulse duration	CLK high or low	3.5	3.5	ns		
t _{su}	Setup time, data before CLK↑	Data high or low	1.6	1.6	ns		
t _h	Hold time, data after CLK↑	Data high or low	1.6	1.6	ns		



SN54ABT534, SN74ABT534A

OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS

WITH 3-STATE OUTPUTS

SCBS187E – FEBRUARY 1991 – REVISED OCTOBER 1996

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN74ABT534A		UNIT		
			V _{CC} = 5 V, T _A = 25°C			MIN	MAX
			MIN	MAX			
f _{clock}	Clock frequency		125	125	MHz		
t _w	Pulse duration	CLK high or low	3.5	3.5	ns		
t _{su}	Setup time, data before CLK↑	Data high or low	1.6	1.6	ns		
t _h	Hold time, data after CLK↑	Data high or low	2†	2†	ns		

\uparrow This data sheet limit may vary among suppliers.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT534					UNIT
			V _{CC} = 5 V, T _A = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f _{max}			125	175		125		MHz
t _{PLH}	CLK	Q	2.6	4.5	6.1	2.6	7	ns
t _{PHL}			3.4	5.5	6.7	3.4	7.9	
t _{PZH}	OE	Q	1	3.4	5.2	1	5.8	ns
t _{PZL}			2.6	4	5.8	2.6	7	
t _{PHZ}	OE	Q	2.4	4.7	6.6	2.4	7.6	ns
t _{PLZ}			2.3	3.8	5.8	2.3	6.8	

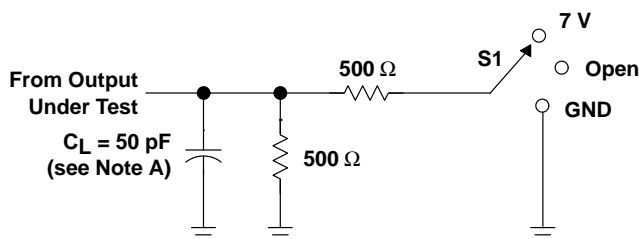
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT534A				UNIT	
			V _{CC} = 5 V, T _A = 25°C			MIN		MAX
			MIN	TYP	MAX			
f _{max}			125	175		125	MHz	
t _{PLH}	CLK	Q	2.6	4.5	5.9	2.6	6.7	ns
t _{PHL}			3.4	5.5	6.7	3.4	7.6	
t _{PZH}	$\overline{\text{OE}}$	Q	1	3.4	4.2	1	5	ns
t _{PZL}			2.6	4	5.8	2.6	6.8	
t _{PHZ}	$\overline{\text{OE}}$	Q	2.4	4.7	6.6	2.4	7.3	ns
t _{PLZ}			2.3	3.8	5.8	2.3	6.5	

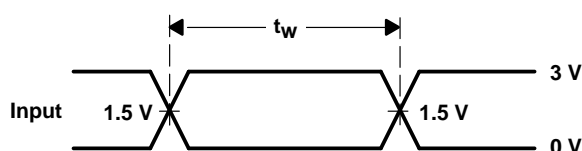
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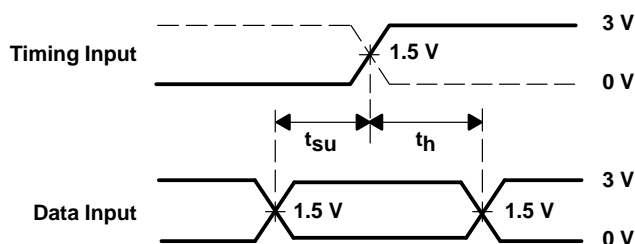
PARAMETER MEASUREMENT INFORMATION



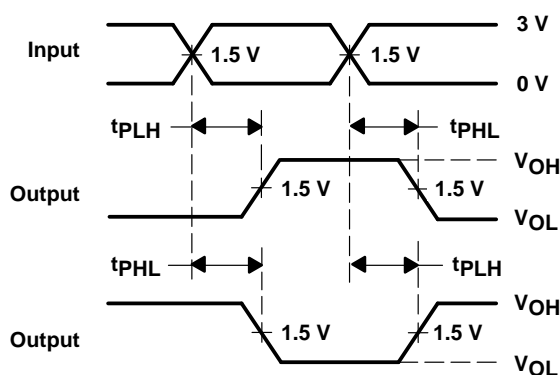
LOAD CIRCUIT



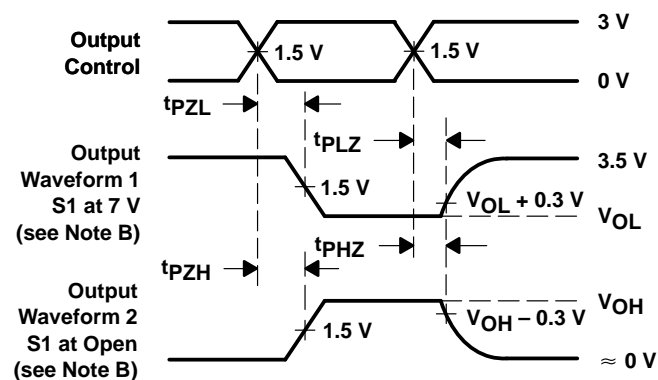
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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